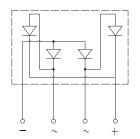


Low VF Bridge Rectifiers





Features

- UL recognition, file #E230084
- based on silicon planar process
- Ideal for printed circuit boards
- High surge current capability
- Low VF
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

Mechanical Data

 Package: GBU Molding compound meets UL 94 V-0 flammability rating, -

• **Terminals**: Tin plated leads, solderable per J-STD-002 and JESD22-B102

• Polarity: As marked on body

■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	GBUU2508	
Device marking code				GBUU2508	
Maximum Repetitive Peak Reverse Voltage		VRRM	V	800	
Maximum RMS Voltage		VRMS	V	560	
Maximum DC blocking Voltage		VDC	V	800	
Average rectified output current @60Hz sine wave, R-load	With heatsink Tc =110°C	· IO	А	25.0	
	Without heatsink Ta =25°C			4.0	
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C		IFSM	А	360	
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C				700	
Current squared time @1ms≤t≤8.3ms Tj=25°C, Rating of per diode		l²t	A ² S	538	
Storage temperature		T _{stg}	°C	-55 ~ + 150	
Junction temperature		Tj	°C	-55 ~ +150	
Dielectric strength @ Terminals to case, AC 1 minute		Vdis	KV	2.5	
Mounting torque @Recommend torque: 5kg·cm		Tor	kg·cm	8	



■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	Min	Тур	Max
Instantaneous forward voltage drop per diode	VF	٧	IFM=12.5A	0.80	0.86	0.92
DC reverse current at rated DC blocking voltage per diode	ĪR	μΑ	T _j =25°C	-	0.005	5
			T _j =125°C	-	-	50
Junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	80	164	330

■Thermal Characteristics (T_a=25°C Unless otherwise specified)

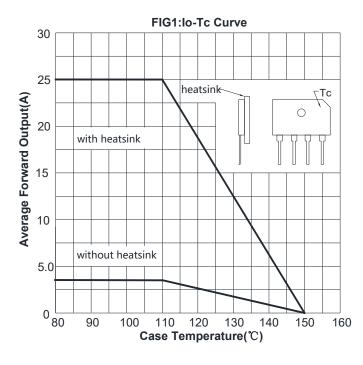
PARAMETER		SYMBOL	UNIT	GBUU2508
	Between junction and ambient, Without heatsink	RθJ-A	°C/W	25.0
Typical Thermal Resistance	Between junction and lead, With heatsink	R _θ J-L		4.0
	Between junction and case, With heatsink	RøJ-C		1.4

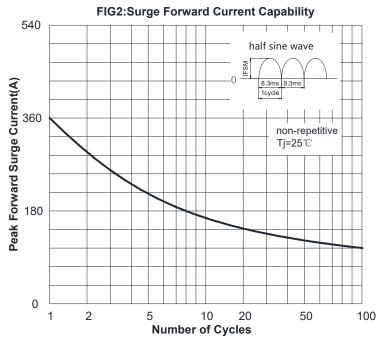
Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

■Ordering Information (Example)

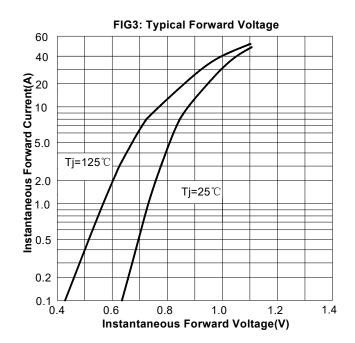
PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GBUU2508	B1	Approximate 3.96	20	1000	2000	TUBE

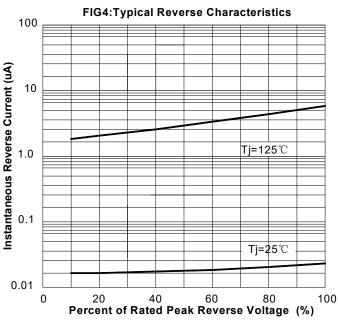
■ Characteristics (Typical)



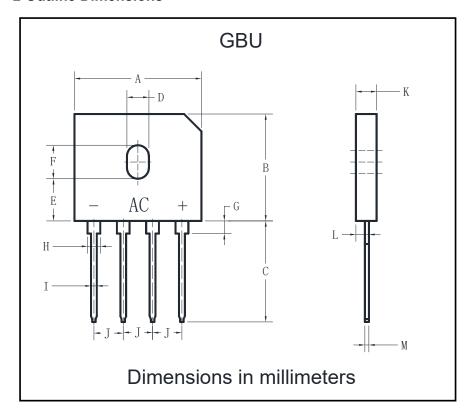








■ Outline Dimensions



GBU						
Dim	Min	Max				
Α	21.80	22.30				
В	18.30	18.80				
С	17.50	18.00				
D	3.30	3.90				
Е	7.10	7.50				
F	5.50	5.90				
G	1.91	2.54				
Н	2.06	2.54				
I	1.02	1.27				
J	4.83	5.33				
K	3.30	3.56				
L	2.40	2.66				
М	0.46	0.56				



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